



SPECIFICATION FOR LED LAMP

PART NO. : LT3311-81-UHE1

10mm ROUND TYPE

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PART NO. : LT3311-81-UHE1

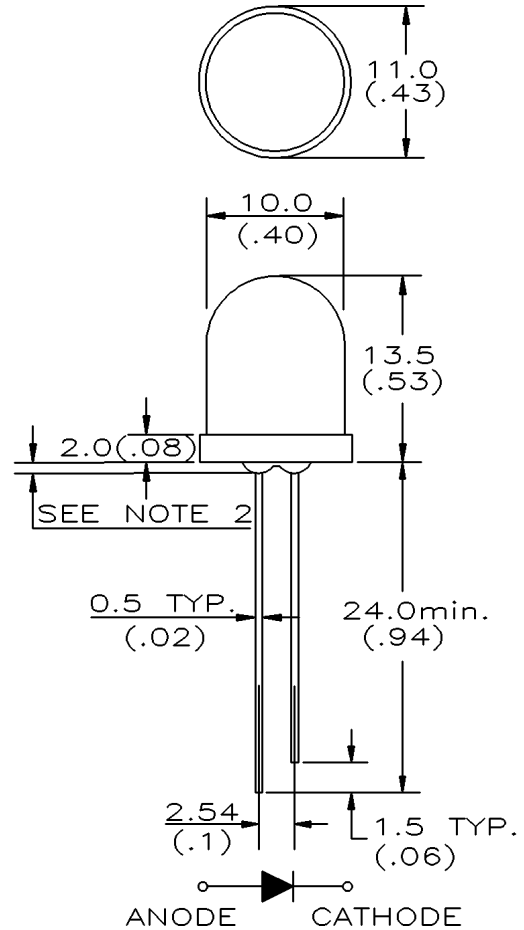
Features

- * High intensity
- * Reliable and rugged
- * Low current requirement
- * IC compatible

Description

The hyper red lamps are made with AlGaInP chips and red diffused epoxy resin.

Package Dimensions



Notes :

1. All dimensions are in millimeters (inches).
2. Protruded resin under flange is 1.0mm (.04") max.
3. Tolerance is $\pm 0.25\text{mm}$ (0.01") unless otherwise noted.

Part No.	Led Chip		Lens Color
	Material	Emitting Color	
LT3311-81-UHE1	AlGaInP	Hyper Red	Red Diffused



10mm ROUND TYPE

PART NO. : LT3311-81-UHE1

Page : 2/4

Absolute Maximum Ratings at Ta=25°C :

Parameter	Symbol	Rating	Unit
Power Dissipation	Pd	72	mW
Reverse Voltage	Vr	4	V
D.C. Forward Current	If	30	mA
Peak Current (1/10 Duty Cycle,0.1ms pulse width)	If (Peak)	100	mA
Operating Temperature Range	Topr	-25 to +85	°C
Storage Temperature Range	Tstg	-40 to +100	°C
Lead Soldering Temp. (1.6mm from body) for 5 seconds		260	°C

Electrical and Optical Characteristics :

Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit
Luminous Intensity	Iv	If=20mA	700	1200		mcd
Forward Voltage	Vf	If=20mA		2.0	2.4	V
Peak Wavelength	λp	If=20mA		632		nm
Dominant Wavelength	λd	If=20mA		625		nm
Reverse Current	Ir	Vr=4V			100	μA
Viewing Angle	$2\theta 1/2$	If=20mA		30		deg
Spectrum Line Halfwidth	$\Delta \lambda$	If=20mA		20		nm

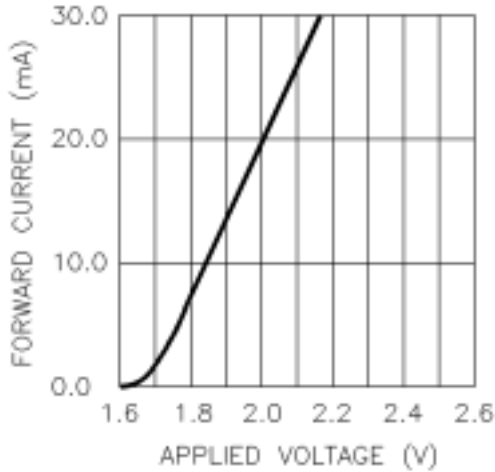


10mm ROUND TYPE

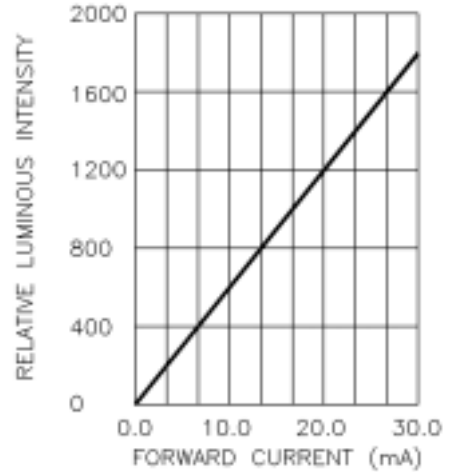
PART NO. : LT3311-81-UHE1

Page : 3/4

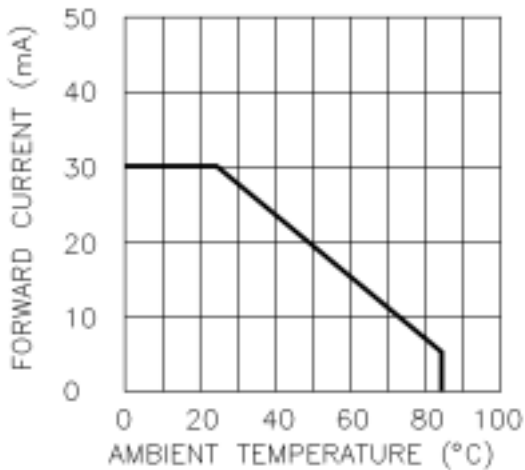
Typical Electrical / Optical Characteristics Curves :



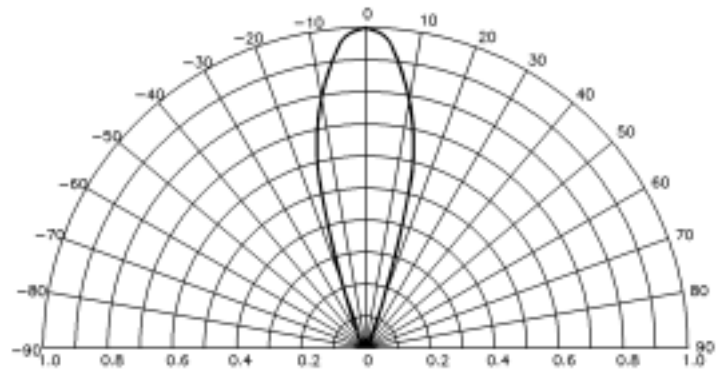
Forward Current vs. Forward Voltage



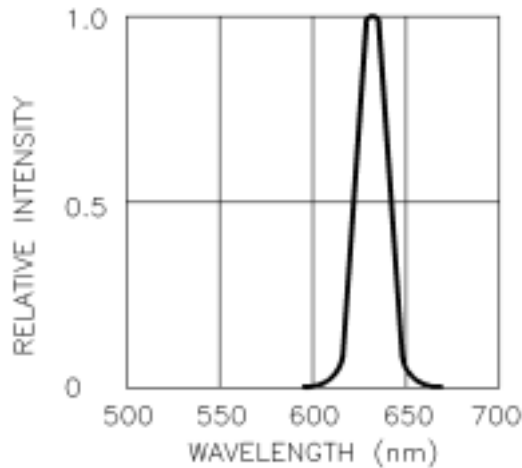
Forward Current vs. Relative Luminous Intensity



Ambient Temperature vs. Forward Current



Radiation Diagram



Relative Intensity vs. Wavelength



10mm ROUND TYPE

PART NO. : LT3311-81-UHE1

Page : 4/4

Reliability Test Method :

Test Item	Test Condition	Duration Time
Operation Life	If=20mA / Ta=25°C	168 hrs
Storage at High Temperature	Ta=100°C	168 hrs
Storage at Low Temperature	Ta=-40°C	168 hrs
Storage at High Temperature/High Humidity	Ta=85°C / RH=85%	168 hrs
Operating at High Temperature	Ta=85°C / If=20mA	168 hrs
Operating at Low Temperature	Ta=-25°C / If=20mA	168 hrs
Thermal Shock	Ta/T=100°C/30min~ - 40°C/30min	10 cycles
Solderability	Tsol=260°C	5 sec

Criteria for Judging The Damage :

Item	Symbol	Test Condition	Criteria for Judgment	
			Min.	Max.
Forward Voltage	Vf	If=20mA	---	Initial Data x1.1
Reverse Current	Ir	Vr=4V	---	100 μ A
Luminous Intensity	Iv	If=20mA	Initial Data x0.8	---

Precautions :

If the lead is formed, the lead should be formed up to 5mm from the body of the device without forming stress to the resin. Soldering should be performed after lead forming.